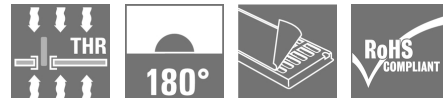


OMNIMATE Data - RJ45 jacks transformer RJ45G1 R1V 3.3N4YG/YG TY

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RJ45 transmitter sockets (magnetics) for gigabit applications (1000 base-T) with integrated compensation actively counteracts inductive and capacitive couplings and saves space on the PCB.

- THT or THR soldering processes
- Wide range of different design types, also with integrated LEDs and shield contact tabs
- Packed either in a tray (TY) or on a roll (tape-on-reel, RL)
- Extended temperature range of -40 °C to +85 °C
- Reinforced gold layer for improved corrosion protection
- Transmission rates of up to 1 Gbit/s

General ordering data

Type	RJ45G1 R1V 3.3N4YG/YG TY
Order No.	1534760000
Version	PCB plug-in connector, RJ45 jacks transformer, THT/THR solder connection, 1.27 mm, No. of poles: 10, 180°, Solder pin length (l): 3.2 mm, Gold over nickel, Black, Tray (manual assembly)
GTIN (EAN)	4050118338423
Qty.	120 pc(s).
Packaging	Tray (manual assembly)

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Technical data**Dimensions and weights**

Net weight	3.783 g
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Temperatures

Operating temperature, max.	85 °C	Operating temperature, min.	-40 °C
Storage temperature, max.	85 °C	Storage temperature, min.	-40 °C

System specifications

Colour of left LED	green / yellow	Colour of right LED	green / yellow
LED	Yes	Mounting onto the PCB	THT/THR solder connection
No. of poles	10	Number of solder pins per pole	1
Outgoing elbow	180°	Pitch in inches (P)	0.05 inch
Pitch in mm (P)	1.27 mm	Plugging cycles	750
Product family	OMNIMATE Data - RJ45 jacks transformer	Protection degree	IP20
Shield surface	nickel-plated	Shield tabs	none
Shielding	Yes	Shielding material	Brass
Solder eyelet hole diameter (D)	0.9 mm	Solder eyelet hole diameter tolerance (D)	± 0.1 mm
Solder pin dimensions	0.40 x 0.30 mm, LED pins = 0.50 x 0.50 mm	Solder pin length (l)	3.2 mm
Transmission rate	1000 MBit/s	Type of connection	Socket
Wiring	10-wire		

Electrical properties

Dielectric strength, contact / contact	≥ 1000 V DC	Insulation resistance	> 500 MΩ
Rated current	1.5 A	Rated voltage	125 V AC

Material data

Insulating material	PA 9T	Colour	Black
Colour chart (similar)	RAL 9011	Insulating material group	II
CTI	≥ 500	Insulation resistance	> 500 MΩ
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact base material	Phosphorus bronze	Contact surface	Gold over nickel
Layer structure of plug contact	30-80 μ" Ni / 30- μ" Au	Storage temperature, min.	-40 °C
Storage temperature, max.	85 °C	Operating temperature, min.	-40 °C
Operating temperature, max.	85 °C		

Classifications

ETIM 6.0	EC002637	eClass 6.2	27-25-05-04
eClass 7.1	27-25-05-04	eClass 8.1	19-17-01-25
eClass 9.0	19-17-01-25	eClass 9.1	27-44-04-02

Approvals

Approvals



ROHS

Conform

Creation date July 30, 2018 1:05:03 PM CEST

Catalogue status 13.07.2018 / We reserve the right to make technical changes.

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Data sheet**OMNIMATE Data - RJ45 jacks transformer
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Technical data**Downloads**

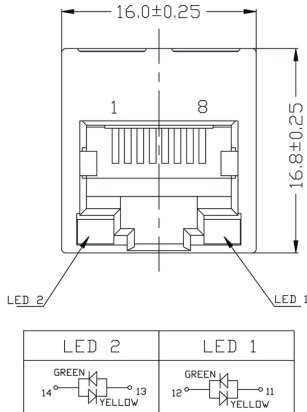
Brochure/Catalogue	MB FREECONTACT EN FL FIELDWIRING EN PI PROFINET CABLING EN
User Documentation	MAN IE GUIDE DE MAN IE GUIDE EN

**OMNIMATE Data - RJ45 jacks transformer
RJ45G1 R1V 3.3N4YG/YG TY**

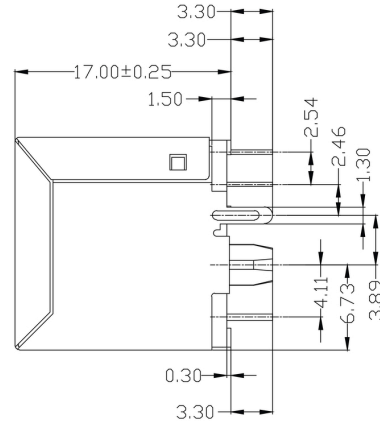
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Drawings

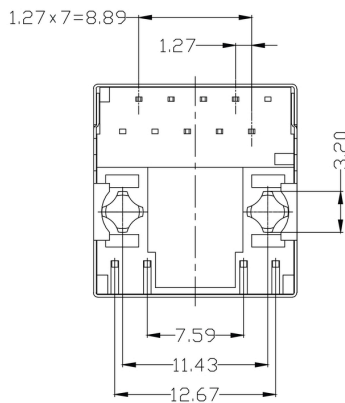
Dimensioned drawing



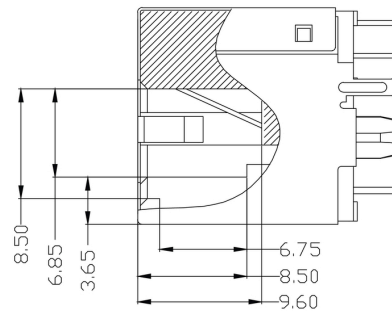
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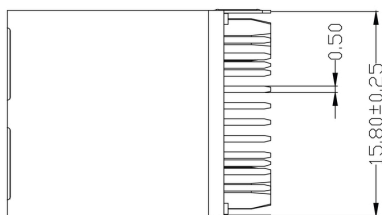
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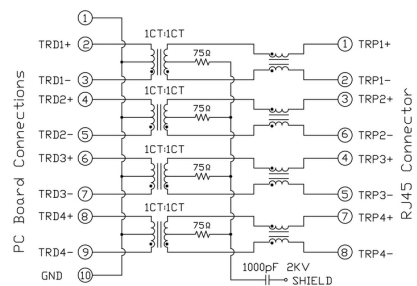
Dimensioned drawing



Dimensioned drawing



Wiring diagram

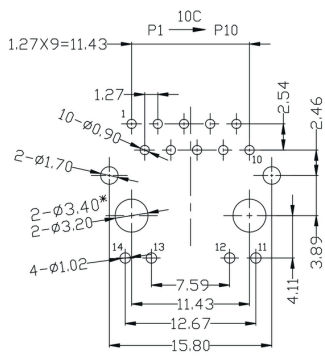


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Drawings

PCB design



PCB LAYOUT

Miscellaneous

Characteristics

Inductance	350 µH min. @ 100 kHz, 100 mV, 8 mA DC Bias
Leakage Inductance	0.3 µH max. @ 100 kHz, 100 mV
Insertion Loss	1.1 dB max. @ (1 - 100) MHz
Return Loss	18 dB min. @ (1 - 30) MHz 16 dB min. @ (30 - 60) MHz 12 dB min. @ (60 - 80) MHz
Cross Talk	30 dB min. @ (1 - 100) MHz
Common Mode Rejection	30 dB min. @ (1 - 100) MHz

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Legend

Code	Description	Value	Notes
RJ45	Product Code		
G1	Performance Category		
R1	Assembly on PCB		
U	Direction, latch style		
3.2	Solder Pin length		
E4	EMI tabs (ground fingers)		
GY/GY	LED		
TY	Packaging		
RJ45G1 R1U 3.2E4GY/GY TY			
Packaging	TY	Tray in box (manual assembly)	
	RL	Tape on Reel (automated assembly)	
LED	Y/G	Yellow/Green	
	G/Y	Green/Yellow (standard)	
	GY/GY	Green-Yellow/Green-Yellow	
	O/G	Orange/Green	
	R/O	Red/Orange	
 (further combinations possible)	
	N	without LED	
Contact surface thickness	4	1 = 3µ", 2 = 6µ", 3 = 15µ", 4 = 30µ", 5 = 50µ"	
EMI tabs (ground fingers)	E	E = with EMI tabs	
	N	N = without EMI tabs	
Solder Pin length	3.2	3.2 mm	
	1.6	1.6 mm	
	D	SMD	
Direction, latch style	U	Horizontal (90°, side entry), latch up	
	D	Horizontal (90°, side entry), latch down	
	V	Vertical (180°, top entry)	
	Y	Diagonal (45°), latch up	
Number of Ports	1	1 Port	
	12; 14; ...	multi ports side by side, Multiport	
	21; 41; ...	multi ports about each other, Multilevel	
Assembly on PCB	R	Through Hole Reflow - THR	
	S	Soldering process: Wave or Reflow soldering	
	S	Surface Mount Technology - SMT	
	T	Soldering process: Reflow soldering	
	T	Through Hole Technology - THT	
	T	Soldering process: Wave	
Performance Category	C5	Category 5	
	C6	Category 6	
	C6A	Category 6A	
	C5e	Category 5e	
	M	10/100 Mbit	
	G1	10/100/1000 Mbit	
	G10	10 Gbit	
	U	Unshielded	
	MP	10/100 Mbit with POE	
	MP+	10/100 Mbit with POE+	

Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is ‚activated‘. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.